

### Absolute Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V <sub>CBO</sub>	-60	V
Collector-Emitter Voltage	V <sub>CEO</sub>	-60	V
Emitter-Base Voltage	V <sub>EBO</sub>	-6.0	V
Collector Current	lc	-600	mA
Peak Collector Current	I <sub>CM</sub>	-800	mA
Peak Base Current	I <sub>BM</sub>	-200	mA

## **Thermal Characteristics**

Characteristic		Symbol	Value	Unit	
Collector Power Dissipation	(Note 6)	D-	310	mW	
	(Note 7)	PD	350	11177	
Thermal Registeres, Junction to Ambient	(Note 6)	D	403	°C/W	
Thermal Resistance, Junction to Ambient	(Note 7)	R <sub>0JA</sub>	357	C/VV	
Thermal Resistance, Junction to Leads	(Note 8)	R <sub>θJL</sub>	350	°C/W	
Operating and Storage Temperature Range		T <sub>J</sub> ,T <sub>STG</sub>	-55 to +150	°C	

## ESD Ratings (Note 9)

Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	4,000	V	3A
Electrostatic Discharge - Machine Model	ESD MM	400	V	С

Notes: 6. For a device mounted on minimum recommended pad layout 1oz copper that is on a single-sided FR-4 PCB; device is measured under still air conditions whilst operating in a steady-state.

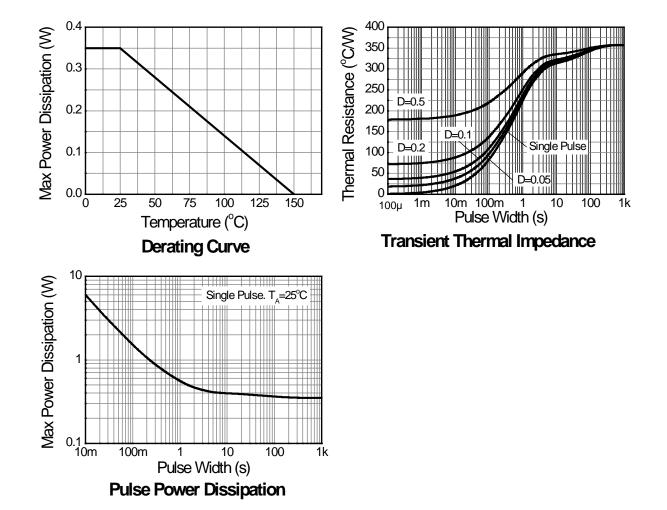
7. Same as Note 6, except the device is mounted on 15 mm x 15mm 1oz copper.

8. Thermal resistance from junction to solder-point (at the end of the leads).

9. Refer to JEDEC specification JESD22-A114 and JESD22-A115.



# **Thermal Characteristics and Derating Information**





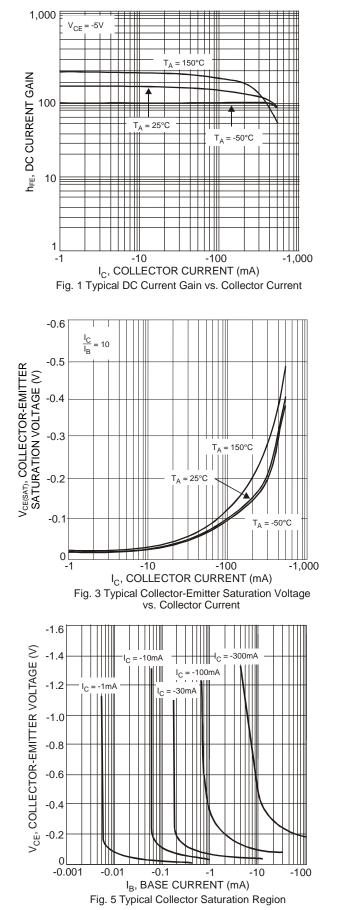
# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

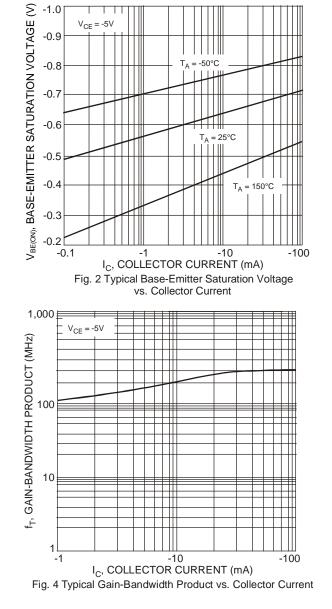
Characteristic	Symbol	Min	Max	Unit	Test Condition	
OFF CHARACTERISTICS						
Collector-Base Breakdown Voltage	BV <sub>CBO</sub>	-60		V	$I_{\rm C} = -100 \mu A, I_{\rm E} = 0$	
Collector-Emitter Breakdown Voltage (Note 10)	BV <sub>CEO</sub>	-60	—	V	$I_{\rm C} = -10 {\rm mA}, I_{\rm B} = 0$	
Emitter-Base Breakdown Voltage	BV <sub>EBO</sub>	-6.0	—	V	$I_{E} = -100 \mu A, I_{C} = 0$	
Collector Cut-Off Current	I <sub>CBO</sub>		-10	nA μA	V <sub>CB</sub> = -50V, I <sub>E</sub> = 0 V <sub>CB</sub> = -50V, I <sub>E</sub> = 0, T <sub>A</sub> = +125°C	
Collector Cut-Off Current	I <sub>CEX</sub>	_	-50	nA	$V_{CE} = -30V, V_{EB(OFF)} = -0.5V$	
Base Cut-Off Current	I <sub>BL</sub>		-50	nA	$V_{CE} = -30V, V_{EB(OFF)} = -0.5V$	
Emitter Cut-Off Current	I <sub>EBO</sub>	_	-50	nA	V <sub>EB</sub> = -6.0V	
ON CHARACTERISTICS (Note 10)						
DC Current Gain	hfe	75 100 100 100 50	  300	_	$\begin{split} I_{C} &= -100 \mu A, \ V_{CE} &= -10V \\ I_{C} &= -1.0 m A, \ V_{CE} &= -10V \\ I_{C} &= -10 m A, \ V_{CE} &= -10V \\ I_{C} &= -150 m A, \ V_{CE} &= -10V \\ I_{C} &= -500 m A, \ V_{CE} &= -10V \end{split}$	
Collector-Emitter Saturation Voltage	V <sub>CE(SAT)</sub>		-0.4 -1.6	V	$I_{C} = -150mA$ , $I_{B} = -15mA$ $I_{C} = -500mA$ , $I_{B} = -50mA$	
Base-Emitter Saturation Voltage	V <sub>BE(SAT)</sub>		-1.3 -2.6	V	$I_{C} = -150$ mA, $I_{B} = -15$ mA $I_{C} = -500$ mA, $I_{B} = -50$ mA	
SMALL SIGNAL CHARACTERISTICS						
Output Capacitance	Cobo		8.0	pF	$V_{CB} = -10V$ , f = 1.0MHz, I <sub>E</sub> = 0	
Input Capacitance	Cibo	_	30	pF	$V_{EB} = -2.0V$ , f = 1.0MHz, I <sub>C</sub> = 0	
Current Gain-Bandwidth Product	f <sub>T</sub>	200	—	MHz	$V_{CE} = -20V, I_C = -50mA,$ f = 100MHz	
SWITCHING CHARACTERISTICS						
Turn-On Time	ton		45	ns	$V_{CC} = -30V, I_{C} = -150mA,$	
Delay Time	t <sub>D</sub>		10	ns	$V_{CC} = -30V, I_C = -150HA,$ $I_{B1} = -15mA$	
Rise Time	t <sub>R</sub>		40	ns	IBJ = -121114	
Turn-Off Time	t <sub>OFF</sub>		100	ns	$V_{CC} = -6.0V$ . Ic = -150mA.	
Storage Time	ts		80	ns	$V_{CC} = -6.0V, I_C = -150MA,$ $I_{B1} = I_{B2} = -15MA$	
Fall Time	t <sub>F</sub>		30	ns	181 - 182 = -101114	

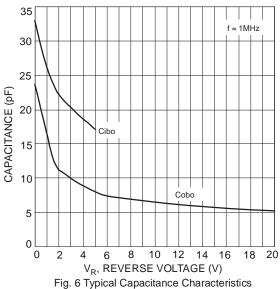
Note: 10. Measured under pulsed conditions. Pulse width  $\leq$  300µs. Duty cycle  $\leq$  2%.











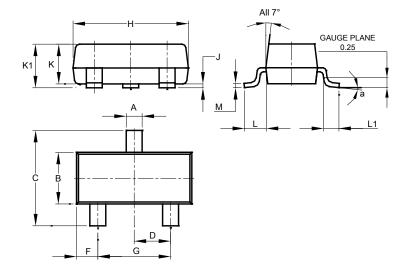
MMBT2907A Document number: DS30040 Rev. 19 - 2 Downloaded from Arrow.com.



## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT23

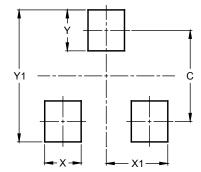


SOT23				
Dim	Min	Max	Тур	
Α	0.37	0.51	0.40	
В	1.20	1.40	1.30	
С	2.30	2.50	2.40	
D	0.89	1.03	0.915	
F	0.45	0.60	0.535	
G	1.78	2.05	1.83	
Н	2.80	3.00	2.90	
<b>ر</b>	0.013	0.10	0.05	
ĸ	0.890	1.00	0.975	
K1	0.903	1.10	1.025	
L	0.45	0.61	0.55	
L1	0.25	0.55	0.40	
Μ	0.085	0.150	0.110	
а	0°	8°		
All Dimensions in mm				

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT23



Dimensions	Value (in mm)
С	2.0
Х	0.8
X1	1.35
Y	0.9
Y1	2.9



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